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FDC658P Rev.C

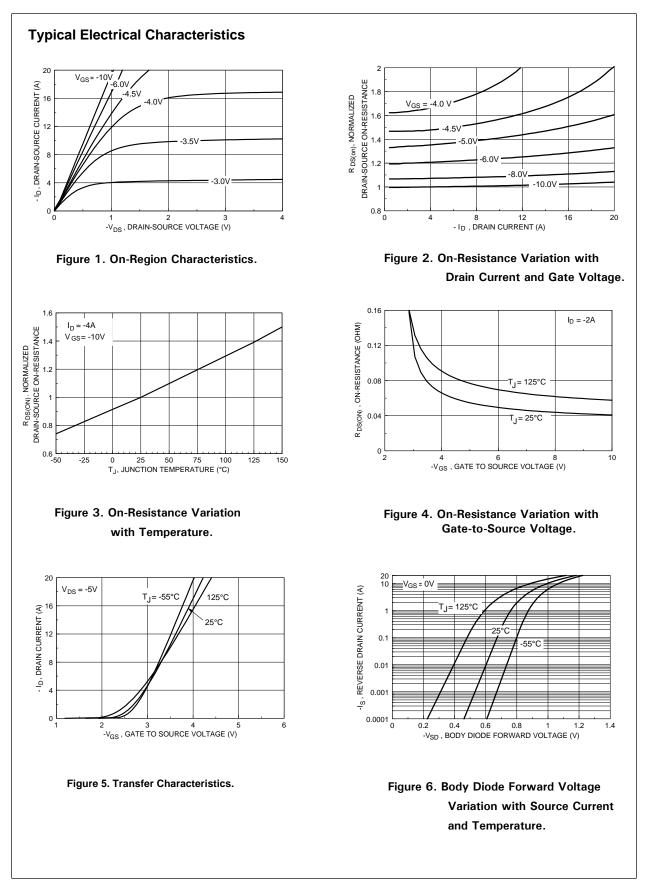
Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAR	ACTERISTICS	•					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \ \mu\text{A}$		-30			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{D}$ = -250 µA, Referenced to 25 °C			-22		mV/ºC
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$				-1	μA
			T <sub>J</sub> = 55 °C			-10	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
ON CHARA	CTERISTICS (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-1	-1.7	-3	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold VoltageTemp.Coefficient	$I_{\rm D}$ = -250 µA, Referenced to 25 °C			4.1		mV/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, I_{D} = -4.0 \text{ A}$			0.041	0.05	Ω
			T <sub>J</sub> = 125 °C		0.058	0.08	
		$V_{GS} = -4.5 \text{ V}, \ \text{I}_{D} = -3.4 \text{ A}$			0.06	0.075	
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = -10 \text{ V}, V_{DS} = -5 \text{ V}$		-20			Α
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5V, I_{D} = -4 A$			9		S
DYNAMIC C	HARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -15 V, V_{GS} = 0 V,$ f = 1.0 MHz			750		pF
C <sub>oss</sub>	Output Capacitance				220		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				100		pF
SWITCHING	CHARACTERISTICS (Note 2)						
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD}$ = -15 V, I <sub>D</sub> = -1 A, V <sub>GS</sub> = -10 V, R <sub>GEN</sub> = 6 Ω			12	22	ns
t,	Turn - On Rise Time				14	25	ns
t <sub>D(off)</sub>	Turn - Off Delay Time				24	38	ns
t,	Turn - Off Fall Time				16	27	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = -15 V, I_{D} = -4.0 A,$			8	12	nC
Q <sub>qs</sub>	Gate-Source Charge	$V_{GS} = -5 V$			1.8		nC
Q <sub>gd</sub>	Gate-Drain Charge				3		nC
DRAIN-SOU	RCE DIODE CHARACTERISTICS				•		
l <sub>s</sub>	Continuous Source Diode Current				-1.3	Α	
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -1.3 A$ (Note 2)			-0.76	-1.2	V

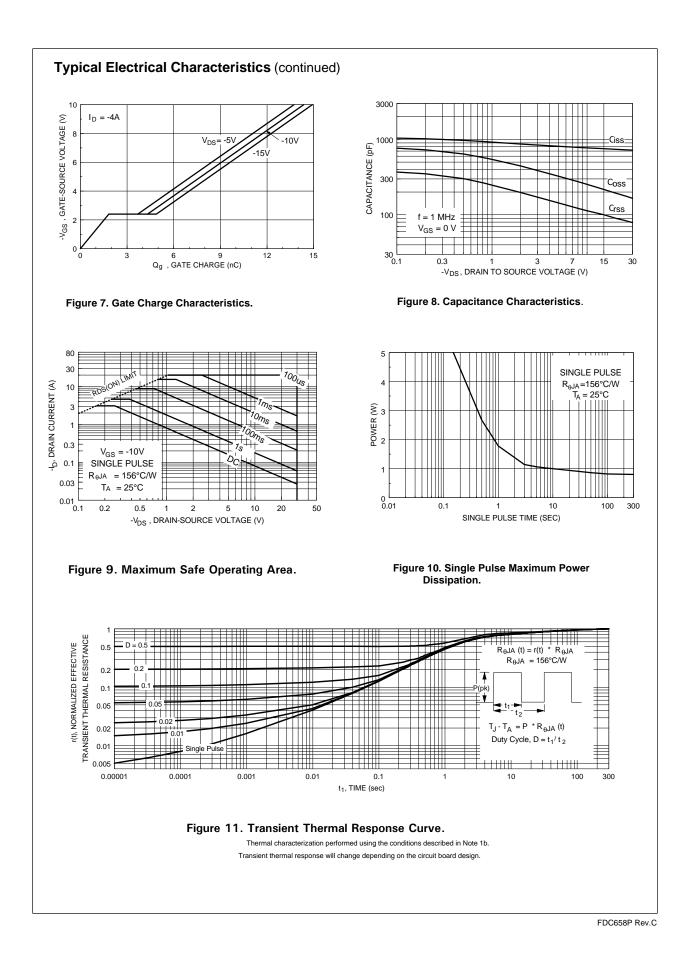
1. R<sub>guh</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>guc</sub> is guaranteed by design while R<sub>gch</sub> is determined by the user's board design.

a. 78°C/W when mounted on a 1 in<sup>2</sup> pad of 2oz Cu on FR-4 board.

b. 156°C/W when mounted on a minimum pad of 2oz Cu on FR-4 board.

2. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%.





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